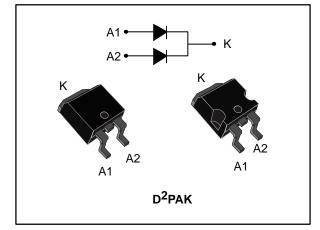


STPS16H100C

High voltage power Schottky rectifier

Datasheet - production data



Description

Dual center tap Schottky rectifier designed for high frequency miniature switch mode power supplies such as adaptors and on-board DC-DC converters.

Table 1: Device summary

Value				
2x 8 A				
100 V				
175 °C				
0.59 V				

Features

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade off between leakage current and forward voltage drop
- Avalanche capability specified
- ECOPACK[®]2 compliant component for D²PAK on demand

April 2015

DocID8734 Rev 3

www.st.com

This is information on a product in full production.

1 Characteristics

Table 2: Absolute ratings (limiting values, per diode, at 25 °C, unless otherwise specified)

Symbol	Parame	Value	Unit		
Vrrm	Repetitive peak reverse voltage			100	V
I _{F(RMS)}	Forward rms current	Forward rms current			А
	Average forward current δ = 0.5,	Tc = 165 °C	Per diode	8	•
IF(AV)	square wave	T _C = 160 °C	Per device	16	A
I _{FSM}	Surge non repetitive forward current	tp = 10 ms sin	usoidal	200	А
PARM	Repetitive peak avalanche power	$tp = 10 \ \mu s, T_{j} =$	625	W	
T _{stg}	Storage temperature range			-65 to + 175	°C
Tj	Maximum operating junction tempe	+ 175	°C		

Notes:

 $^{(1)}(dP_{tot}/dT_j) < (1/R_{th(j\text{-}a)})$ condition to avoid thermal runaway for a diode on its own heatsink.

Table 3: Thermal parameter

Symbol	Parameter	Value	Unit	
Durin	lunction to coop	Per diode	1.6	°C/W
R _{th(j-c)}	Junction to case	Total	1.1	C/VV
R _{th(c)}	Coupling		0.6	°C/W

When the diodes 1 and 2 are used simultaneously :

 $\Delta Tj(diode 1) = P(diode1) \times R_{th(j-c)}(Per diode) + P(diode 2) \times R_{th(c)}$

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	Vr = Vrrm	-		3.6	μA
IR ⁽¹⁾		T _j = 125 °C		-	1.6	5	mA
	/F ⁽²⁾ Forward voltage drop	T _j = 25 °C	I_F = 8 A	-		0.77	
$\lambda I_{-}(2)$		T _j = 125 °C		-	0.59	0.64	V
VF		T _j = 25 °C	I _F = 16 A	-		0.88	v
		T _j = 125 °C		-	0.67	0.73	

Notes:

$$\label{eq:point} \begin{split} \mbox{$^{(1)}$Pulse test: $t_p = 5$ ms, $\delta < 2\%$} \\ \mbox{$^{(2)}$Pulse test: $t_p = 380$ µs, $\delta < 2\%$} \end{split}$$

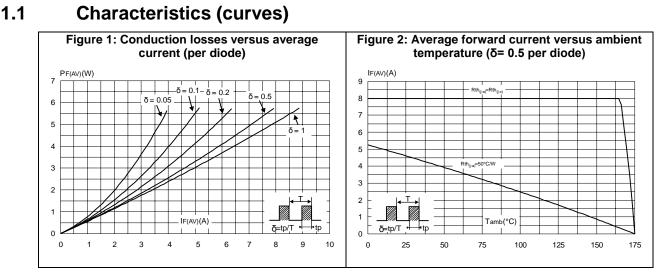
To evaluate the conduction losses use the following equation:

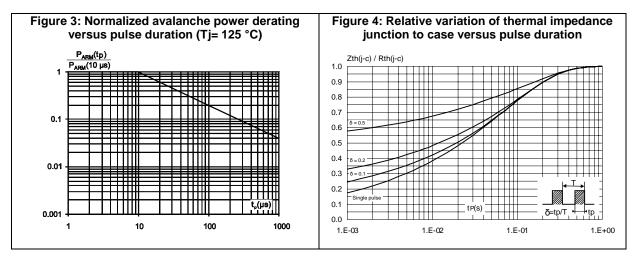
 $P = 0.55 \ x \ I_{F(AV)} + 0.011 \ I_{F^2(RMS)}$

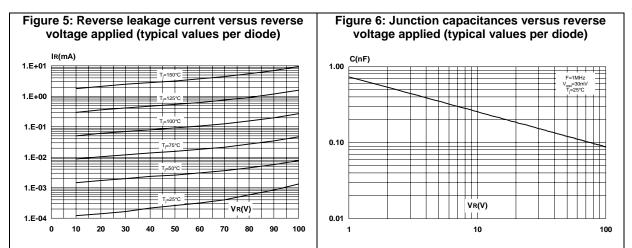


STPS16H100C

Characteristics





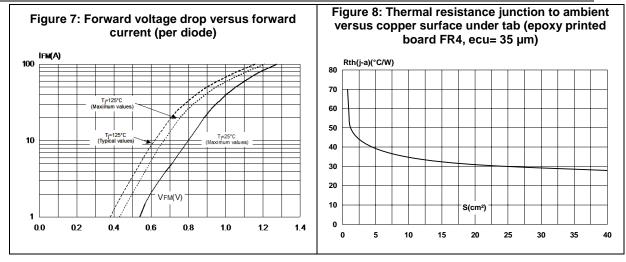


57

3/10

Characteristics

STPS16H100C



DocID8734 Rev 3



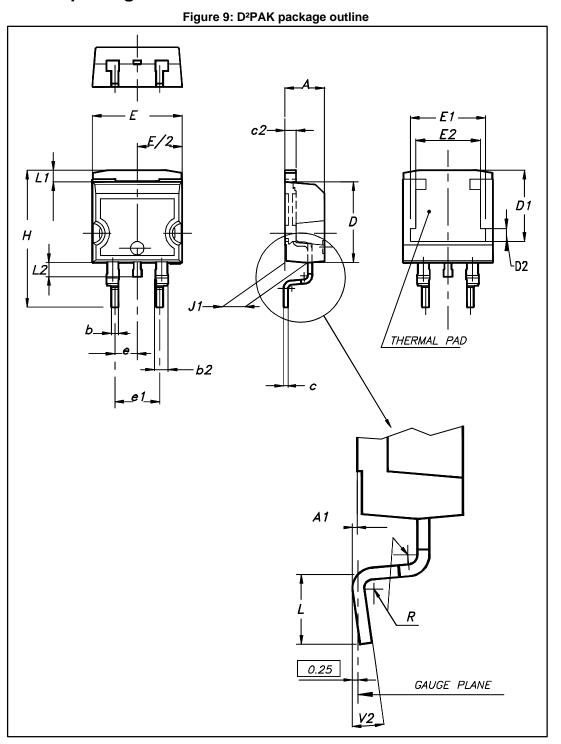
2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

- Cooling method: by conduction (C)
- Epoxy meets UL 94,V0



2.1 D²PAK package information





This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

6/10

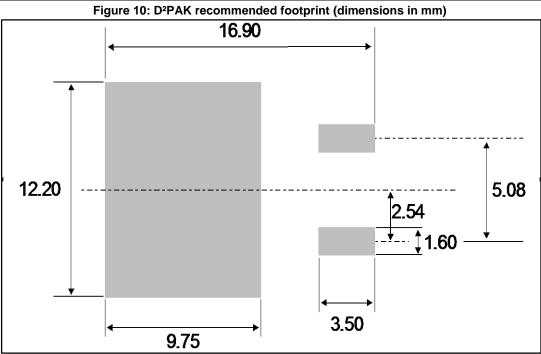


STPS16H100C

Package information

00C	Package informatio							
	Table 5: D ² PAK package mechanical data							
		Dime	nsions					
Ref.	Millim	neters	1	nches				
	Min.	Max.	Min.	Max.				
А	4.36	4.60	0.172	0.181				
A1	0.00	0.25	0.000	0.010				
b	0.70	0.93	0.028	0.037				
b2	1.14	1.70	0.045	0.067				
С	0.38	0.69	0.015	0.027				
c2	1.19	1.36	0.047	0.053				
D	8.60	9.35	0.339	0.368				
D1	6.90	8.00	0.272	0.311				
D2	1.10	1.50	0.043	0.060				
E	10.00	10.55	0.394	0.415				
E1	8.10	8.90	0.319	0.346				
E2	6.85	7.25	0.266	0.282				
е	2.54	typ.		0.100				
e1	4.88	5.28	0.190	0.205				
Н	15.00	15.85	0.591	0.624				
J1	2.49	2.90	0.097	0.112				
L	1.90	2.79	0.075	0.110				
L1	1.27	1.65	0.049	0.065				
L2	1.30	1.78	0.050	0.070				
R	0.4	typ.		0.015				
V2	0°	8°	-	-				





8/10

DocID8734 Rev 3



3 Ordering information

Table 6: Ordering information						
Order code	Marking	Package	Weight	Base qty	Delivery mode	
STPS16H100CG-TR	STPS16H100CG	D ² PAK	1.38g	1000	Tape and reel	

4 Revision history

Table 7: Document revis	sion history
-------------------------	--------------

Date	Revision	Changes
27-Jun-2012	2	
22-Apr-2015	3	Updated features in cover page. Minor text changes in Section 1: "Characteristics". Updated Section 2: "Package information".



IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2015 STMicroelectronics - All rights reserved

